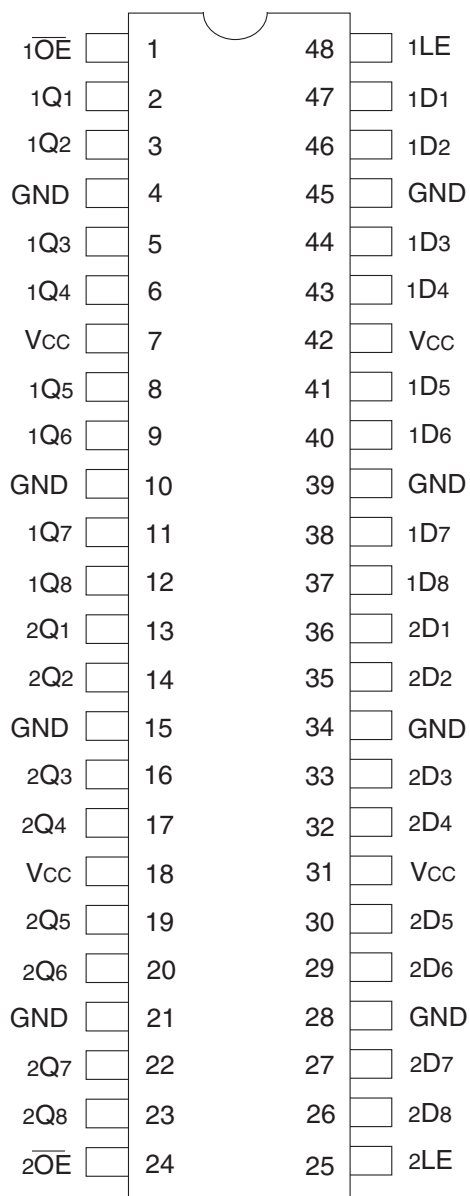




## PIN CONFIGURATION



SSOP/ TSSOP  
TOP VIEW

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

Symbol	Description	Max	Unit
VTERM <sup>(2)</sup>	Terminal Voltage with Respect to GND	-0.5 to +4.6	V
VTERM <sup>(3)</sup>	Terminal Voltage with Respect to GND	-0.5 to Vcc+0.5	V
TSTG	Storage Temperature	-65 to +150	°C
IOUT	DC Output Current	-50 to +50	mA
IIK	Continuous Clamp Current, Vi < 0 or Vi > Vcc	±50	mA
IOK	Continuous Clamp Current, Vo < 0	-50	mA
ICC ISS	Continuous Current through each Vcc or GND	±100	mA

### NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- Vcc terminals.
- All terminals except Vcc.

## CAPACITANCE (TA = +25°C, F = 1.0MHz)

Symbol	Parameter <sup>(1)</sup>	Conditions	Typ.	Max.	Unit
CIN	Input Capacitance	VIN = 0V	5	7	pF
COUT	Output Capacitance	VOUT = 0V	7	9	pF
CIO	I/O Port Capacitance	VIN = 0V	7	9	pF

### NOTE:

- As applicable to the device type.

## PIN DESCRIPTION

Pin Names	Description
x Dx	Data Inputs <sup>(1)</sup>
x LE	Latch Enable Inputs
x Qx	3-State Outputs
x OE	3-State Output Enable Input (Active LOW)

### NOTE:

- These pins have "Bus-Hold". All other pins are standard inputs, outputs, or I/Os.

## FUNCTION TABLE (EACH 8-BIT SECTION)<sup>(1)</sup>

Inputs			Outputs
x OE	x LE	x Dx	x Qx
L	H	H	H
L	H	L	L
H	X	X	Z
L	L	X	Q <sub>o</sub> <sup>(2)</sup>

### NOTES:

- H = HIGH Voltage Level  
L = LOW Voltage Level  
X = Don't Care  
Z = High Impedance
- Output level before the indicated steady-state input conditions were established.

## DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified:

Operating Condition:  $T_A = -40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$

Symbol	Parameter	Test Conditions		Min.	Typ. <sup>(1)</sup>	Max.	Unit
$V_{IH}$	Input HIGH Voltage Level	$V_{CC} = 2.3\text{V}$ to $2.7\text{V}$		1.7	—	—	V
		$V_{CC} = 2.7\text{V}$ to $3.6\text{V}$		2	—	—	
$V_{IL}$	Input LOW Voltage Level	$V_{CC} = 2.3\text{V}$ to $2.7\text{V}$		—	—	0.7	V
		$V_{CC} = 2.7\text{V}$ to $3.6\text{V}$		—	—	0.8	
$I_{IH}$	Input HIGH Current	$V_{CC} = 3.6\text{V}$	$V_I = V_{CC}$	—	—	$\pm 5$	$\mu\text{A}$
$I_{IL}$	Input LOW Current	$V_{CC} = 3.6\text{V}$	$V_I = \text{GND}$	—	—	$\pm 5$	$\mu\text{A}$
$I_{OZH}$	High Impedance Output Current (3-State Output pins)	$V_{CC} = 3.6\text{V}$	$V_O = V_{CC}$	—	—	$\pm 10$	$\mu\text{A}$
$I_{OZL}$			$V_O = \text{GND}$	—	—	$\pm 10$	
$V_{IK}$	Clamp Diode Voltage	$V_{CC} = 2.3\text{V}$ , $I_{IN} = -18\text{mA}$		—	-0.7	-1.2	V
$V_H$	Input Hysteresis	$V_{CC} = 3.3\text{V}$		—	100	—	mV
$I_{CCL}$ $I_{CCH}$ $I_{CCZ}$	Quiescent Power Supply Current	$V_{CC} = 3.6\text{V}$ $V_{IN} = \text{GND}$ or $V_{CC}$		—	0.1	40	$\mu\text{A}$
$\Delta I_{CC}$	Quiescent Power Supply Current Variation	One input at $V_{CC} - 0.6\text{V}$ , other inputs at $V_{CC}$ or $\text{GND}$		—	—	750	$\mu\text{A}$

NOTE:

1. Typical values are at  $V_{CC} = 3.3\text{V}$ ,  $+25^{\circ}\text{C}$  ambient.

## BUS-HOLD CHARACTERISTICS

Symbol	Parameter <sup>(1)</sup>	Test Conditions		Min.	Typ. <sup>(2)</sup>	Max.	Unit
$I_{BHH}$ $I_{BHL}$	Bus-Hold Input Sustain Current	$V_{CC} = 3\text{V}$	$V_I = 2\text{V}$	-75	—	—	$\mu\text{A}$
			$V_I = 0.8\text{V}$	75	—	—	
$I_{BHH}$ $I_{BHL}$	Bus-Hold Input Sustain Current	$V_{CC} = 2.3\text{V}$	$V_I = 1.7\text{V}$	-45	—	—	$\mu\text{A}$
			$V_I = 0.7\text{V}$	45	—	—	
$I_{BHHO}$ $I_{BHL0}$	Bus-Hold Input Overdrive Current	$V_{CC} = 3.6\text{V}$	$V_I = 0$ to $3.6\text{V}$	—	—	$\pm 500$	$\mu\text{A}$

NOTES:

1. Pins with Bus-Hold are identified in the pin description.

2. Typical values are at  $V_{CC} = 3.3\text{V}$ ,  $+25^{\circ}\text{C}$  ambient.

## OUTPUT DRIVE CHARACTERISTICS

Symbol	Parameter	Test Conditions <sup>(1)</sup>		Min.	Max.	Unit
VOH	Output HIGH Voltage	VCC = 2.3V to 3.6V	IOH = -0.1mA	VCC - 0.2	—	V
		VCC = 2.3V	IOH = -4mA	1.9	—	
			IOH = -6mA	1.7	—	
		VCC = 2.7V	IOH = -4mA	2.2	—	
			IOH = -8mA	2	—	
		VCC = 3V	IOH = -6mA	2.4	—	
			IOH = -12mA	2	—	
VOL	Output LOW Voltage	VCC = 2.3V to 3.6V	IOL = 0.1mA	—	0.2	V
		VCC = 2.3V	IOL = 4mA	—	0.4	
			IOL = 6mA	—	0.55	
		VCC = 2.7V	IOL = 4mA	—	0.4	
			IOL = 8mA	—	0.6	
		VCC = 3V	IOL = 6mA	—	0.55	
			IOL = 12mA	—	0.8	

NOTE:  
1. VIH and VIL must be within the min. or max. range shown in the DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE table for the appropriate VCC range.  
TA = -40°C to +85°C.

## OPERATING CHARACTERISTICS, TA = 25°C

Symbol	Parameter	Test Conditions	VCC = 2.5V ± 0.2V	VCC = 3.3V ± 0.3V	Unit
			Typical	Typical	
CPD	Power Dissipation Capacitance Outputs enabled	CL = 0pF, f = 10Mhz	19	22	pF
CPD	Power Dissipation Capacitance Outputs disabled		4	5	

## SWITCHING CHARACTERISTICS<sup>(1)</sup>

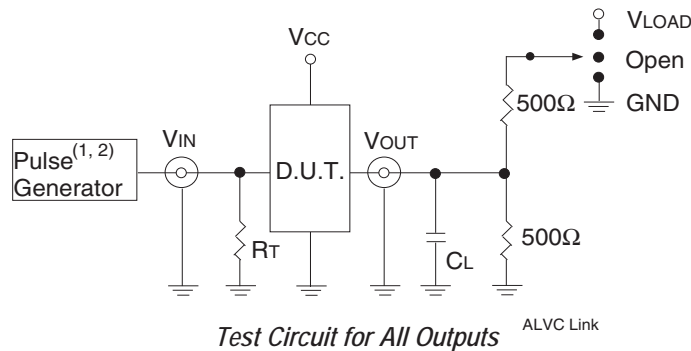
Symbol	Parameter	VCC = 2.5V ± 0.2V		VCC = 2.7V		VCC = 3.3V ± 0.3V		Unit
		Min.	Max.	Min.	Max.	Min.	Max.	
tPLH	Propagation Delay	1.5	5.3	1.5	4.5	1.5	4	ns
tPHL	xDx to xQx							
tPLH	Propagation Delay	2	5.6	2	5	2	4	ns
tPHL	xLE to xQx							
tPZH	Output Enable Time	1.5	6.5	1.5	6	1.5	5	ns
tPZL	xOE to xQx							
tPHZ	Output Disable Time	1.5	5.6	1.5	5.5	1.5	4.5	ns
tPLZ	xOE to xQx							
tSU	Setup Time, data before LE↓	2	—	2	—	2	—	ns
tH	Hold Time, data after LE↓	1.5	—	1.5	—	1.5	—	ns
tW	Pulse Duration, LE HIGH or LOW	3.3	—	3.3	—	3.3	—	ns
tSK(O)	Output Skew <sup>(2)</sup>	—	—	—	—	—	500	ps

NOTES:  
1. See TEST CIRCUITS AND WAVEFORMS. TA = -40°C to +85°C.  
2. Skew between any two outputs of the same package and switching in the same direction.

## TEST CIRCUITS AND WAVEFORMS

### TEST CONDITIONS

Symbol	$V_{CC}^{(1)} = 3.3V \pm 0.3V$	$V_{CC}^{(1)} = 2.7V$	$V_{CC}^{(2)} = 2.5V \pm 0.2V$	Unit
$V_{LOAD}$	6	6	$2 \times V_{CC}$	V
$V_{IH}$	2.7	2.7	$V_{CC}$	V
$V_T$	1.5	1.5	$V_{CC} / 2$	V
$V_{LZ}$	300	300	150	mV
$V_{HZ}$	300	300	150	mV
$C_L$	50	50	30	pF



#### DEFINITIONS:

$C_L$  = Load capacitance: includes jig and probe capacitance.

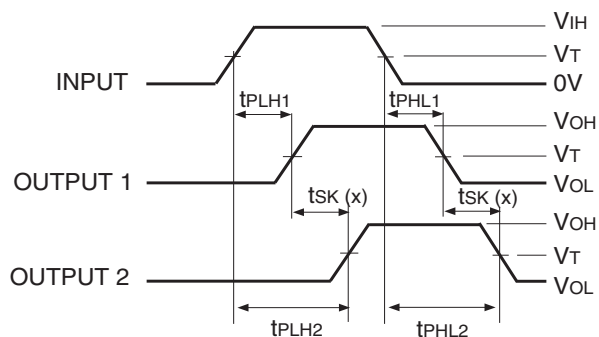
$R_T$  = Termination resistance: should be equal to  $Z_{OUT}$  of the Pulse Generator.

#### NOTES:

1. Pulse Generator for All Pulses: Rate  $\leq 1.0\text{MHz}$ ;  $t_r \leq 2.5\text{ns}$ ;  $t_f \leq 2.5\text{ns}$ .
2. Pulse Generator for All Pulses: Rate  $\leq 1.0\text{MHz}$ ;  $t_r \leq 2\text{ns}$ ;  $t_f \leq 2\text{ns}$ .

### SWITCH POSITION

Test	Switch
Open Drain Disable Low Enable Low	$V_{LOAD}$
Disable High Enable High	GND
All Other Tests	Open

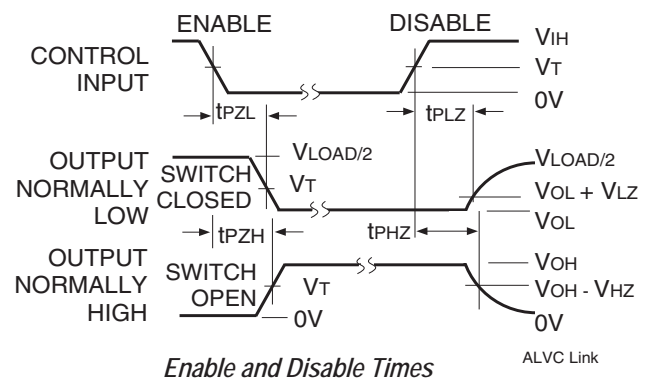
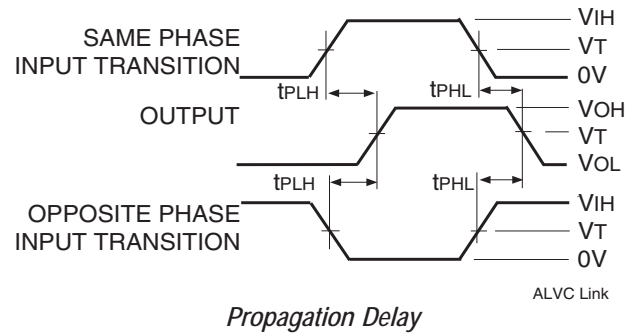


$$t_{SK}(x) = |t_{PLH2} - t_{PLH1}| \text{ or } |t_{PHL2} - t_{PHL1}|$$

Output Skew -  $t_{SK}(x)$

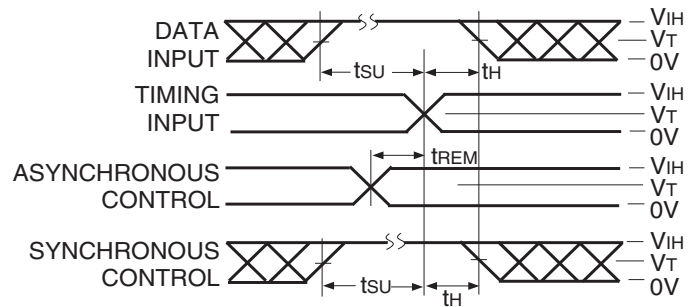
#### NOTES:

1. For  $t_{SK}(o)$  OUTPUT1 and OUTPUT2 are any two outputs.
2. For  $t_{SK}(b)$  OUTPUT1 and OUTPUT2 are in the same bank.

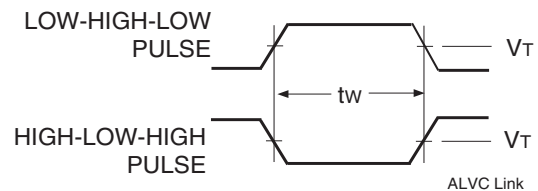


#### NOTE:

1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.



Set-up, Hold, and Release Times



## ORDERING INFORMATION

XX	ALVC	X	XX	XXX	XX	X		
Temp. Range	Bus-Hold	Family	Device Type	Package				
						Blank	Tube	
						8	Tape and Reel	
						PVG	Shrink Small Outline Package - Green	
						PAG	Thin Shrink Small Outline Package - Green	
						373	16-Bit Transparent D-Type Latch with 3-State Outputs	
						162	Double-Density with Resistors, $\pm 12\text{mA}$	
						H	Bus-Hold	
						74	$-40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$	

## DATASHEET DOCUMENT HISTORY

06/15/2016 Pg. 6 Updated the ordering information by adding Tape and Reel.

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